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APPLICANTS

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✓ ** CONTINUING DATA *****
This application is a 371 of PCT/JP00/00951 02/21/2000 *lm*

✓ ** FOREIGN APPLICATIONS *****

JAPAN 11/48905 02/25/1999
JAPAN 11/48906 02/25/1999
JAPAN 11/48907 02/25/1999
JAPAN 11/212068 07/27/1999
JAPAN 11/212069 07/27/1999
JAPAN 11/212070 07/27/1999
JAPAN 11/240511 08/26/1999 *lm*

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY JAPAN	SHEETS DRAWING	TOTAL CLAIMS 21	INDEPENDENT CLAIMS 1
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35 USC 119 (a-d) conditions met ☒ yes ☐ no Met after Allowance

Verified and Acknowledged *[Signature]* Examiner's Signature Initials

ADDRESS
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TITLE
Resin composition for semiconductor encapsulation, semiconductor device obtained with the same, and process for producing semiconductor device

FILING FEE RECEIVED 1332	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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